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Fairchild Semiconductor FDS8935

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November 2010



Datasheet of FDS8935 - MOSFET 2P-CH 80V 2.1A 8SOIC

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Dual P-Channel PowerTrench® MOSFET

-80 V, -2.1 A, 183 mΩ

Features

- \blacksquare Max $r_{DS(on)}$ = 183 m Ω at V_{GS} = -10 V, I_D = -2.1 A
- Max $r_{DS(on)}$ = 247 m Ω at V_{GS} = -4.5 V, I_D = -1.9 A
- High performance trench technology for extremely low r_{DS(on)}
- High power and current handling capability in a widely used surface mount package
- 100% UIL Tested
- RoHS Compliant

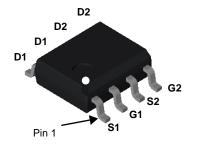


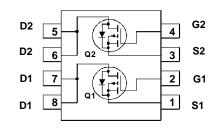
General Description

■ This P-channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench® process that has been optimized for r_{DS(on)}, switching performance and ruggedness.

Applications

- Load Switch
- Synchronous Rectifier





SO-8

MOSFET Maximum Ratings $T_A = 25$ °C unless otherwise noted

| Symbol | Parameter | | | Ratings | Units | |
|-----------------------------------|---|------------------------|-------------|---------|-------|--|
| V_{DS} | Drain to Source Voltage | | | -80 | V | |
| V_{GS} | Gate to Source Voltage | | | ±20 | V | |
| | Drain Current -Continuous | | | -2.1 | Δ. | |
| ID | -Pulsed | | | -10 | _ A | |
| E _{AS} | Single Pulse Avalanche Energy | | (Note 3) | 37 | mJ | |
| Б | Power Dissipation | T _A = 25 °C | (Note 1a) | 3.1 | 14/ | |
| P_D | Power Dissipation $T_A = 25 ^{\circ}\text{C}$ (Note 1b) | | 1.6 | W | | |
| T _J , T _{STG} | Operating and Storage Junction Temperature Range | | -55 to +150 | °C | | |

Thermal Characteristics

| R_{θ} | JC | Thermal Resistance, Junction to Case | (Note 1) | 40 | °C/W |
|--------------|----|---|-----------|----|------|
| R_{θ} | JA | Thermal Resistance, Junction to Ambient | (Note 1a) | 78 | C/VV |

Package Marking and Ordering Information

| Device Marking | Device | Package | Reel Size | Tape Width | Quantity |
|----------------|---------|---------|-----------|------------|------------|
| FDS8935 | FDS8935 | SO-8 | 13 " | 12 mm | 2500 units |



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Electrical Characteristics T_J = 25°C unless otherwise noted

| Symbol | Parameter | Test Conditions | Min | Тур | Max | Units |
|--|--|---|-----|-----|------|-------|
| Off Chara | acteristics | | | | | |
| BV _{DSS} | Drain to Source Breakdown Voltage | $I_D = -250 \mu\text{A}, V_{GS} = 0 \text{V}$ | -80 | | | ٧ |
| $\frac{\Delta BV_{DSS}}{\Delta T_{J}}$ | Breakdown Voltage Temperature Coefficient | I_D = -250 μ A, referenced to 25 °C | | -61 | | mV/°C |
| I _{DSS} | Zero Gate Voltage Drain Current | V _{DS} = -64 V, V _{GS} = 0 V | | | -1 | μА |
| I _{GSS} | Gate to Source Leakage Current | $V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$ | | | ±100 | nA |

On Characteristics

| $V_{GS(th)}$ | Gate to Source Threshold Voltage | $V_{GS} = V_{DS}, I_{D} = -250 \mu A$ | -1 | -1.8 | -3 | V |
|--|--|--|----|------|-----|-------|
| $\frac{\Delta V_{GS(th)}}{\Delta T_J}$ | Gate to Source Threshold Voltage Temperature Coefficient | I_D = -250 μ A, referenced to 25 °C | | 5 | | mV/°C |
| | | $V_{GS} = -10 \text{ V}, I_D = -2.1 \text{ A}$ | | 148 | 183 | |
| r _{DS(on)} | Static Drain to Source On Resistance | $V_{GS} = -4.5 \text{ V}, I_D = -1.9 \text{ A}$ | | 176 | 247 | mΩ |
| , , | | $V_{GS} = -10 \text{ V}, I_D = -2.1 \text{ A}, T_J = 125 ^{\circ}\text{C}$ | | 249 | 308 | |
| 9 _{FS} | Forward Transconductance | $V_{DS} = -10 \text{ V}, I_{D} = -2.1 \text{ A}$ | | 6.4 | | S |

Dynamic Characteristics

| C _{iss} | Input Capacitance | V 40.V.V 0.V | 661 | 879 | pF |
|------------------|------------------------------|---|-----|-----|----|
| Coss | Output Capacitance | V _{DS} = -40 V, V _{GS} = 0 V, f = 1MHz | 47 | 63 | pF |
| C _{rss} | Reverse Transfer Capacitance | 1 - 1101112 | 24 | 36 | pF |
| R_g | Gate Resistance | | 6 | | Ω |

Switching Characteristics

| • | .9 | | | | | | |
|---------------------|-------------------------------|--|--|--|-----|----|----|
| t _{d(on)} | Turn-On Delay Time | | | | 5 | 10 | ns |
| t _r | Rise Time | V _{DD} = -40 V, I _D = -2 | | | 3 | 10 | ns |
| t _{d(off)} | Turn-Off Delay Time | V _{GS} = -10 V, R _{GEN} | $V_{GS} = -10 \text{ V}, R_{GEN} = 6 \Omega$ | | 22 | 36 | ns |
| t _f | Fall Time | | | | 3 | 10 | ns |
| $Q_{g(TOT)}$ | Total Gate Charge | $V_{GS} = 0 \text{ V to -10 V}$ | | | 13 | 19 | nC |
| $Q_{g(TOT)}$ | Total Gate Charge | $V_{GS} = 0 \text{ V to -5 V}$ | $V_{DD} = -40 \text{ V},$ | | 7 | 10 | nC |
| Q_{gs} | Gate to Source Charge | | I _D = -2.1 A | | 1.6 | | nC |
| Q_{gd} | Gate to Drain "Miller" Charge | | | | 2.6 | | nC |
| | | | | | | | |

Drain-Source Diode Characteristics

| V _{SD} Source to Drain Diode Forward Voltage $V_{GS} = 0 \text{ V}, I_{S} = -1.3 \text{ A}$ (Note 2) -0.8 | -1.2 | V |
|--|------|----|
| | | |
| I_{rr} Reverse Recovery Time $I_{r} = -2.1 \text{ A, di/dt} = 300 \text{ A/us}$ | 30 | ns |
| Q _{rr} Reverse Recovery Charge 1 _F = -2.1 A, di/dt = 300 A/μS | 54 | nC |

^{1.} R_{0JA} is determined with the device mounted on a 1in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R_{0JC} is guaranteed by design while R_{0CA} is determined by the user's board design.



a)78 °C/W when mounted on a 1 in² pad of 2 oz copper



b)135 °C/W when mounted on a minimun pad

- 2. Pulse Test: Pulse Width < 300 μ s, Duty cycle < 2.0%. 3. Starting T $_J$ = 25 °C, $\,$ L = 3.0 mH, I $_{AS}$ = -5.0 A, V $_{DD}$ = -80V, V $_{GS}$ = -10V.



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Typical Characteristics T_J = 25 °C unless otherwise noted

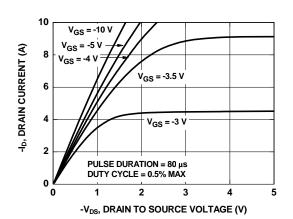


Figure 1. On-Region Characteristics

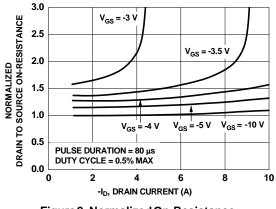


Figure 2. Normalized On-Resistance vs Drain Current and Gate Voltage

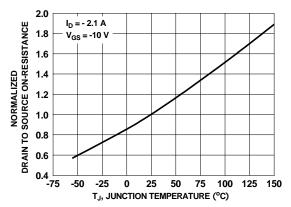


Figure 3. Normalized On-Resistance vs Junction Temperature

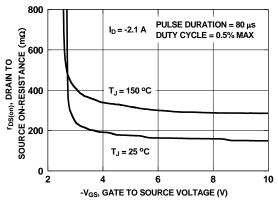


Figure 4. On-Resistance vs Gate to Source Voltage

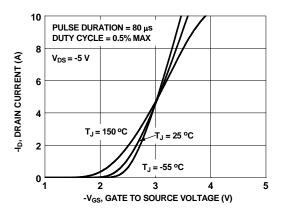


Figure 5. Transfer Characteristics

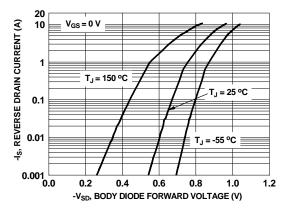


Figure 6. Source to Drain Diode Forward Voltage vs Source Current



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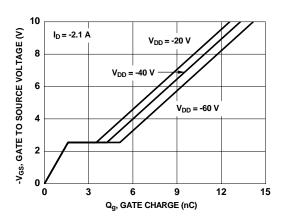


Figure 7. Gate Charge Characteristics

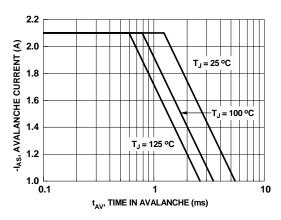


Figure 9. Unclamped Inductive Switching Capability

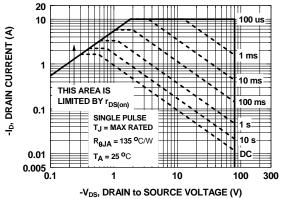


Figure 11. Forward Bias Safe
Operating Area

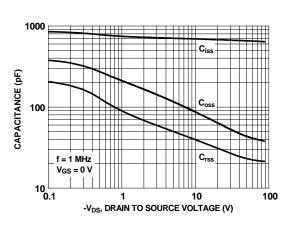


Figure 8. Capacitance vs Drain to Source Voltage

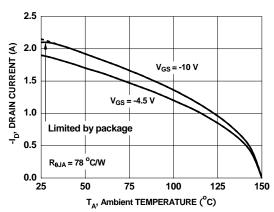


Figure 10. Maximum Continuous Drain Current vs Ambient Temperature

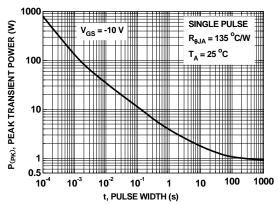


Figure 12. Single Pulse Maximum Power Dissipation

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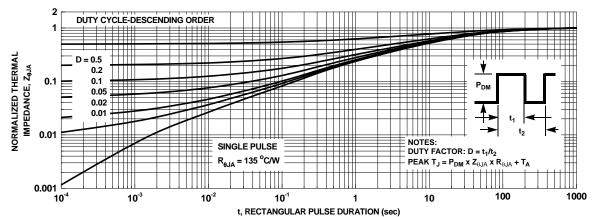


Figure 13. Junction-to-Ambient Transient Thermal Response Curve



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